



Final Product Change Notification

201902019F01

Issue Date: 08-Mar-2019

Effective Date: 06-Jun-2019

Dear *Emma Tempest*,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP.

For detailed information we invite you to [view this notification online](#)



Management Summary

Wafer test, wafer map and PCM data transfer activities as well as finished goods testing is being moved from ATKH to ATBK. Product has been qualified on the SPEA (ATBK) due to STS decommission (ATKH)

Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

PCA8565AU Wafer and
PCA8565TS/1 Test
Transfer from ATKH to
ATBK

Description of Change

Move all of electrical wafer testing and final testing of PCA8565TS/1 from ATKH (STS platform) to ATBK (SPEA test platform).

Reason for Change

Test platform improvement allowing for less downtime.

Identification of Affected Products

Product identification does not change

Product Availability

Sample Information

Samples are available from 05-Apr-2019

Production

Planned first shipment 22-May-2019

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

Existing inventory will be shipped until depleted

Additional information

Affected products and sales history information: see attached file

Self qualification: [view online](#)

Additional documents: [view online](#)



Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 07-Apr-2019.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Dennis Dill

Position QA Engineer

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NXP Quality Management Team.

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